

### General Description

These microprocessor (µP) supervisory circuits reduce the complexity and number of components required for power-supply monitoring and battery-control functions in µP systems. They significantly improve system reliability and accuracy compared to separate ICs or discrete components.

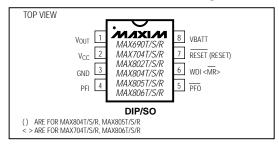
These devices are designed for use in systems powered by 3.0V or 3.3V supplies. See the selector guide in the back of this data sheet for similar devices designed for 5V systems. The suffixes denote different reset threshold voltages: 3.075V (T), 2.925V (S), and 2.625V (R) (see Reset Threshold section in the Detailed Description). All these parts are available in 8-pin DIP and SO packages. Functions offered in this series are as follows:

\	RCtive-Low 17	dive-High Reset	Watchdog II.	Manue Input	The Backur Swith	Poculia Partery	Compart Fail	Reset Fail	Mindow
	MAX690	1		1		1	±4%	1	±75mV
	MAX704	1			1	1	±4%	1	±75mV
	MAX802	1		1		1	±2%	1	±2%
	MAX804		1	✓		1	±2%	✓	±2%
	MAX805		1	1		1	±4%	1	±75mV
	MAX806	1			1	1	±2%	1	±2%

### **Applications**

Battery-Powered Computers and Controllers **Embedded Controllers** Intelligent Instruments Automotive Systems Critical µP Power Monitoring Portable Equipment

### Pin Configuration



### Features

- **RESET** and RESET Outputs
- **♦ Manual Reset Input**
- ♦ Precision Supply-Voltage Monitor
- ♦ 200ms Reset Time Delay
- Watchdog Timer (1.6sec timeout)
- Battery-Backup Power Switching-Battery Can Exceed V<sub>CC</sub> in Normal Operation
- ♦ 40µA V<sub>CC</sub> Supply Current
- ♦ 1µA Battery Supply Current
- Voltage Monitor for Power-Fail or Low-Battery Warning
- ♦ Guaranteed RESET Assertion to V<sub>CC</sub> = 1V
- ♦ 8-Pin DIP and SO Packages

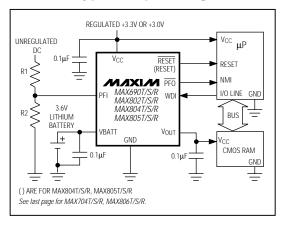
### Ordering Information

PART**	TEMP. RANGE	PIN-PACKAGE
MAX690_CPA	0°C to +70°C	8 Plastic DIP
MAX690_CSA	0°C to +70°C	8 SO
MAX690_C/D	0°C to +70°C	Dice*
MAX690_EPA	-40°C to +85°C	8 Plastic DIP
MAX690_ESA	-40°C to +85°C	8 SO
MAX690_MJA	-55°C to +125°C	8 CERDIP

### Ordering Information continued on last page.

- Contact factory for dice specifications.
- \*\* These parts offer a choice of reset threshold voltage. Select the letter corresponding to the desired nominal reset threshold voltage (T = 3.075V, S = 2.925V, R = 2.625V) and insert it into the blank to complete the part number.

### **Typical Operating Circuits**



MIXIM

Maxim Integrated Products 1

Call toll free 1-800-998-8800 for free samples or literature.

# MAX690T/S/R, 704T/S/R, 802T/S/R, 804-806T/S/R

# 3.0V/3.3V Microprocessor Supervisory Circuits

### **ABSOLUTE MAXIMUM RATINGS**

Terminal Voltage (with respect to GND)
V <sub>CC</sub> 0.3V to 6.0V
VBATT0.3V to 6.0V
All Other Inputs0.3V to the higher of V <sub>CC</sub> or VBAT
Continuous Input Current
V <sub>CC</sub>
VBATT18m/
GND18m/
Output Current
RESET, PFO18m/
V <sub>OUT</sub> 100m/
Stresses beyond those listed under "Absolute Maximum Ratings" may ca

Continuous Power Dissipation ( $T_A = +70^{\circ}C$ )
Plastic DIP (derate 9.09mW/°C above +70°C)727mW
SO (derate 5.88mW/°C above +70°C)471mW
CERDIP (derate 8.00mW/°C above +70°C)640mW
Operating Temperature Ranges
MAX690_C/MAX704_C/MAX80C0°C to +70°C
MAX690_E/MAX704_E/MAX80E40°C to +85°C
MAX690_M/MAX704_M/MAX80M55°C to +125°C
Storage Temperature Range65°C to +160°C
Lead Temperature (soldering, 10sec)+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **ELECTRICAL CHARACTERISTICS**

 $(V_{CC}=3.17V\ to\ 5.5V\ for\ the\ MAX690T/MAX704T/MAX80\_T,\ V_{CC}=3.02V\ to\ 5.5V\ for\ the\ MAX690S/MAX704S/MAX80\_S,\ V_{CC}=2.72V\ to\ 5.5V\ for\ the\ MAX690R/MAX704R/MAX80\_R;\ VBATT=3.6V;\ T_A=T_{MIN}\ to\ T_{MAX};\ unless\ otherwise\ noted.\ Typical\ values\ are\ at\ T_A=+25^{\circ}C.)$ 

PARAMETER SYMB			MIN	TYP	MAX	UNITS	
Operating Voltage Range,		MAX690_C,	MAX704_C, MAX80C	1.0		5.5	V
V <sub>CC</sub> , VBATT (Note 1)		MAX690_E/N	1.1		5.5	<b>7</b> '	
		MR = V <sub>CC</sub>	MAX690_C/E, MAX704_C/E, MAX80C/E, V <sub>CC</sub> < 3.6V		40	50	- - µА
V <sub>CC</sub> Supply Current	laussuu		MAX690_C/E, MAX704_C/E, MAX80C/E, V <sub>CC</sub> < 5.5V		50	65	
(excluding I <sub>OUT</sub> )	ISUPPLY	(MAX704_/ MAX806_)	MAX690_M, MAX704_M, MAX80M, V <sub>CC</sub> < 3.6V		40	55	
			MAX690_M, MAX704_M, MAX80M, V <sub>CC</sub> < 5.5V		50	70	
V <sub>CC</sub> Supply Current in Battery- Backup Mode (excluding I <sub>OUT</sub> )		MR = V <sub>CC</sub> (MAX704_/ MAX806_)	V <sub>CC</sub> = 2.0V, VBATT = 2.3V		25	50	μА
VBATT Supply Current, Any Mode		MAX690_C/E, MAX704_C/E, MAX80C/E			0.4	1	μА
(excluding I <sub>OUT</sub> ) (Note 2)		MAX690_M,	MAX704_M, MAX80M		0.4	10	μΑ.
Battery Leakage Current		MAX690_C/I		0.01	0.5	μΑ	
(Note 3)		MAX690_M,	MAX704_M, MAX80M		0.01	5	μπ
		MAX690_C/I I <sub>OUT</sub> = 5mA	E, MAX704_C/E, MAX80C/E, (Note 4)	V <sub>CC</sub> - 0.03	V <sub>CC</sub> - 0.015		
		MAX690_C/E, MAX704_C/E, MAX80C/E I <sub>OUT</sub> = 50mA		V <sub>C</sub> C - 0.3	V <sub>CC</sub> - 0.15		
Vout Output Voltage		MAX690_M, MAX704_M, MAX80M I <sub>OUT</sub> = 5mA (Note 4)		V <sub>CC</sub> - 0.035	V <sub>CC</sub> - 0.015		V
		MAX690_M, I <sub>OUT</sub> = 50m	V <sub>CC</sub> - 0.35	V <sub>CC</sub> - 0.15			
		I <sub>OUT</sub> = 250μ	A, V <sub>CC</sub> > 2.5V (Note 4)	V <sub>CC</sub> - 0.0015	V <sub>CC</sub> - 0.0006		

# MAX690T/S/R, 704T/S/R, 802T/S/R, 804-806T/S/R

# 3.0V/3.3V Microprocessor Supervisory Circuits

### **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{CC}=3.17V\ to\ 5.5V\ for\ the\ MAX690T/MAX704T/MAX80\_T,\ V_{CC}=3.02V\ to\ 5.5V\ for\ the\ MAX690S/MAX704S/MAX80\_S,\ V_{CC}=2.72V\ to\ 5.5V\ for\ the\ MAX690R/MAX704R/MAX80\_R;\ VBATT=3.6V;\ T_A=T_{MIN}\ to\ T_{MAX};\ unless\ otherwise\ noted.$ 

PARAMETER	SYMBOL	COND	CONDITIONS		MIN	TYP	MAX	UNITS
V <sub>OUT</sub> in Battery-Backup Mode		I <sub>OUT</sub> = 250μA, VBATT =	I <sub>OUT</sub> = 250μA, VBATT = 2.3V		VBATT - 0.1	VBATT - 0.034		V
VOUT III Ballery-Backup Mode		I <sub>OUT</sub> = 1mA, VBATT = 2.3V			VBATT - 0.14		1 1	
Battery Switch Threshold,		VBATT - VCC, VSW > VC	cc > 1.75V (	Note 5)	65	25		mV
V <sub>CC</sub> Falling	Vsw	VBATT > V <sub>CC</sub> (Note 6)			2.30	2.40	2.50	V
Battery Switch Threshold, V <sub>CC</sub> Rising (Note 7)		This value is identical to V <sub>CC</sub> rising	the reset th	reshold,				V
		MAX690T/704T/805T		V <sub>CC</sub> falling	3.00	3.075	3.15	
		WAX0901/7041/6031		V <sub>CC</sub> rising	3.00	3.085	3.17	
		MAX802T/804T/806T		V <sub>CC</sub> falling	3.00	3.075	3.12	1
		IVIAA6021/6041/6001		Vcc rising	3.00	3.085	3.14	1
		MAX690S/704S/805S		V <sub>CC</sub> falling	2.85	2.925	3.00	
Reset Threshold (Note 8)	Vest	WAX6905/7045/8055		V <sub>CC</sub> rising	2.85	2.935	3.02	V
Reset Threshold (Note 8)	V <sub>RST</sub>	MAX802S/804S/806S  Vcc falling Vcc rising		Vcc falling	2.88	2.925	3.00	
				Vcc rising	2.88	2.935	3.02	
				2.55	2.625	2.70		
				2.55	2.635	2.72		
		MAY002D/004D/004C		Vcc falling	2.59	2.625	2.70	1
		MAX802R/804R/806S		V <sub>CC</sub> rising	2.59	2.635	2.72	1
Reset Timeout Period	twp	V <sub>CC</sub> < 3.6V			140	200	280	ms
PFO, RESET Output Voltage	Voн	ISOURCE = 50µA			Vcc - 0.3	V <sub>C</sub> C - 0.05		V
PFO, RESET Output Short to GND Current (Note 4)	los	V <sub>CC</sub> = 3.3V, V <sub>OH</sub> = 0V				180	500	μV
PFO, RESET, RESET Output Voltage	V <sub>OL</sub>	I <sub>SINK</sub> = 1.2mA; MAX690_/704_/802_/80 MAX804_/805_, V <sub>CC</sub> = \		RST min;		0.06	0.3	V
PFO, RESET Output Voltage	Voi	VBATT = 0V, V <sub>CC</sub> = 1.0V, I <sub>SINK</sub> = 40μA, MAX690_C, MAX704_C, MAX80C				0.13	0.3	V
TTO, KESET Output voltage	V <sub>OL</sub>	VBATT = 0V, V <sub>CC</sub> = 1.2 MAX690_E/M, MAX704				0.17	0.3	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \
RESET Output Leakage Current		VBATT = 0V,	MAX804_0 MAX805_0		-1		1	
(Note 9)		VCC = VRST min; VRESET = 0V, VCC	MAX804_I MAX805_I		-10		10	- μΑ

### **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{CC}=3.17V\ to\ 5.5V\ for\ the\ MAX690T/MAX704T/MAX80\_T,\ V_{CC}=3.02V\ to\ 5.5V\ for\ the\ MAX690S/MAX704S/MAX80\_S,\ V_{CC}=2.72V\ to\ 5.5V\ for\ the\ MAX690R/MAX704R/MAX80\_R;\ VBATT=3.6V;\ T_A=T_{MIN}\ to\ T_{MAX};\ unless\ otherwise\ noted. \ Typical\ values\ are\ at\ T_A=+25\ C.)$ 

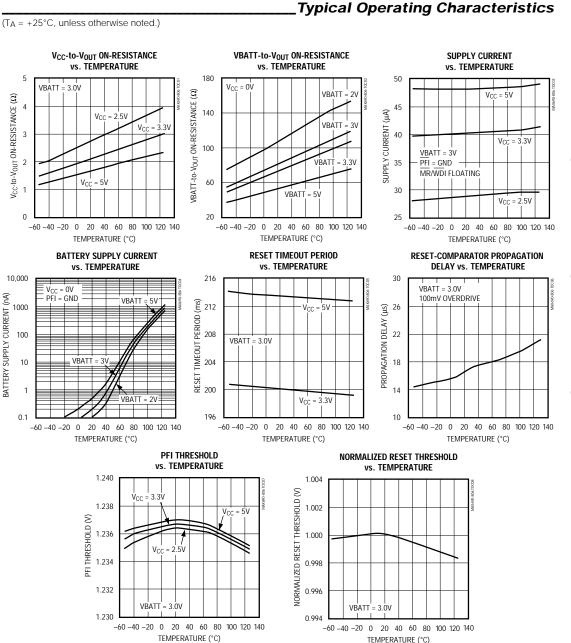
PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
PFI Input Threshold	VPFT	V <sub>CC</sub> < 3.6V V <sub>PFI</sub> falling	MAX802_C/E, MAX804_C/E, MAX806_C/E	1.212	1.237	1.262	V
		VPFITalling	MAX690_/MAX704_/MAX805_	1.187	1.237	1.287	
PFI Input Current		MAX690_C/E, M	AX704_C/E, MAX80C/E	-25	2	25	nA
Firmput Current		MAX690_M, MAX	K704_M, MAX80M	-500	2	500	] "^
PFI Hysteresis, PFI Rising	Vpfh	V <sub>C</sub> C < 3.6V	MAX690_C/E, MAX704_C/E, MAX80C/E		10	20	mV
			MAX690_M, MAX704_M, MAX80M		10	25	
PFI Input Current		MAX690_C/E, M	AX704_C/E, MAX80C/E	-25	2	25	nA
Pri ilipui Cultelli		MAX690_M, MAX	(704_M, MAX80M	-500	2	500	1 IIA
MR Input Threshold	VIH	MAX704 /MAX80		C	).7 x Vcc	V	
Wik input miesnoid	V <sub>IL</sub>	IVIAA7U4_/IVIAAOU	DO_ OTTIS	0.3 x V <sub>CC</sub>			1 '
MR Pulse Width	t <sub>MR</sub>	MAX704_/MAX806_ only		100	20		ns
MR to Reset Delay	tMD	MAX704_/MAX80	06_ only		60	500	ns
MR Pull-Up Current		MAX704_/MAX80	06_ only, MR = 0V, V <sub>CC</sub> = 3V	20	60	350	μΑ
WDI Input Threshold	V <sub>IH</sub>	MAX690 /MAX802 /MAX804 /MAX805 only			0.7 x V <sub>CC</sub>		V
WDI IIIput Tillesiloid	VIL	IVIAA090_/IVIAA00	J2_/IVIAA804_/IVIAA805_ UTIIY	0.3 x Vcc			·
WDI Input Current	it Current	0V< V <sub>CC</sub> < 5.5V	MAX690_C/E, MAX802_C/E, MAX804_C/E, MAX805_C/E	-1	0.01	1	
wormput Current			MAX690_M, MAX802_M, MAX804_M, MAX805_M	-10	0.01	10	- μΑ
Watchdog Timeout Period	twD	V <sub>C</sub> C < 3.6V	MAX690/MAX802/MAX804/ MAX805 only	1.12	1.60	2.24	sec
WDI Pulse Width		MAX690_/MAX80	D2_/MAX804_/MAX805_ only	100	20		ns

- Note 1:  $V_{CC}$  supply current, logic input leakage, watchdog functionality (MAX690\_/802\_/805\_/804\_),  $\overline{MR}$  functionality (MAX704\_/806\_), PFI functionality, state of  $\overline{RESET}$  (MAX690\_/704\_/802\_/806\_), and RESET (MAX804\_/805\_) tested at VBATT = 3.6V, and  $V_{CC}$  = 5.5V. The state of  $\overline{RESET}$  or RESET and  $\overline{PFO}$  is tested at  $V_{CC}$  =  $V_{CC}$  min.
- Note 2: Tested at VBATT = 3.6V, V<sub>CC</sub> = 3.5V and 0V. The battery current will rise to 10μA over a narrow transition window around V<sub>CC</sub> = 1.9V.
- Note 3: Leakage current into the battery is tested under the worst-case conditions at V<sub>CC</sub> = 5.5V, VBATT = 1.8V and at V<sub>CC</sub> = 1.5V, VBATT = 1.0V.
- Note 4: Guaranteed by design.
- Note 5: When V<sub>SW</sub> > V<sub>CC</sub> > VBATT, V<sub>OUT</sub> remains connected to V<sub>CC</sub> until V<sub>CC</sub> drops below VBATT. The V<sub>CC</sub>-to-VBATT comparator has a small 25mV typical hysteresis to prevent oscillation. For V<sub>CC</sub> < 1.75V (typ), V<sub>OUT</sub> switches to VBATT regardless of the voltage on VBATT.
- Note 6: When VBATT >  $V_{CC}$  >  $V_{SW}$ ,  $V_{OUT}$  remains connected to  $V_{CC}$  until  $V_{CC}$  drops below the battery switch threshold ( $V_{SW}$ ).
- Note 7: V<sub>OUT</sub> switches from VBATT to V<sub>CC</sub> when V<sub>CC</sub> rises above the reset threshold, independent of VBATT. Switchover back to V<sub>CC</sub> occurs at the exact voltage that causes RESET to go high (on the MAX804\_/805\_, RESET goes low); however switchover occurs 200ms prior to reset.
- Note 8: The reset threshold tolerance is wider for V<sub>CC</sub> rising than for V<sub>CC</sub> falling to accommodate the 10mV typical hysteresis, which prevents internal oscillation.
- Note 9: The leakage current into or out of the RESET pin is tested with RESET asserted (RESET output high impedance).

# MAX690T/S/R, 704T/S/R, 802T/S/R, 804-806T/S/R

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# 3.0V/3.3V Microprocessor Supervisory Circuits



MIXIM

### Pin Description

	PIN		PIN				
MAX690 MAX704 MAX804 MAX802 MAX806 MAX805		NAME	FUNCTION				
1	1	1	V <sub>OUT</sub>	Supply Output for CMOS RAM. When $V_{CC}$ is above the reset threshold, $V_{OUT}$ is connected to $V_{CC}$ through a P-channel MOSFET switch. When $V_{CC}$ falls below $V_{SW}$ and VBATT, VBATT connects to $V_{OUT}$ . Connect to $V_{CC}$ if no battery is used.			
2	2	2	V <sub>C</sub> C	Main Supply Input			
3	3	3	GND	Ground			
4	4	4	PFI	Power-Fail Input. When PFI is less than $V_{PFT}$ or when $V_{CC}$ falls below $V_{SW}$ , $\overline{PFO}$ goes low; otherwise, $\overline{PFO}$ remains high. Connect to ground if unused.			
5	5	5	PFO	Power-Fail Output. When PFI is less than $V_{PFT}$ , or $V_{CC}$ falls below $V_{SW}$ , $\overline{PFO}$ goes to otherwise, $\overline{PFO}$ remains high. Leave open if unused.			
6	6 — 0		WDI	Watchdog Input. If WDI remains high or low for 1.6sec, the internal watchdog timer runs ou and reset is triggered. The internal watchdog timer clears while reset is asserted or when WDI sees a rising or falling edge. The watchdog function cannot be disabled.			
_	6	_	MR	Manual Reset Input. A logic low on $\overline{\text{MR}}$ asserts reset. Reset remains asserted as long as $\overline{\text{MR}}$ is low and for 200ms after $\overline{\text{MR}}$ returns high. This active-low input has an internal 70 $\mu$ A pull-up current. It can be driven from a TTL or CMOS logic line, or shorted to ground with a switch. Leave open if unused.			
7	7	_	RESET	Active-Low Reset Output. Pulses low for 200ms when triggered, and stays low whenever $V_{CC}$ is below the reset threshold or when $\overline{MR}$ is a logic low. It remains low for 200ms after either $V_{CC}$ rises above the reset threshold, the watchdog triggers a reset, or $\overline{MR}$ goes from low to high.			
_	_	7	RESET	Active-High, Open-Drain Reset Output is the inverse of RESET.			
8	8	8	VBATT	Backup-Battery Input. When $V_{CC}$ falls below $V_{SW}$ and VBATT, $V_{OUT}$ switches from $V_{CC}$ to VBATT. When $V_{CC}$ rises above the reset threshold, $V_{OUT}$ reconnects to $V_{CC}$ . VBATT material exceed $V_{CC}$ . Connect to $V_{CC}$ if no battery is used.			

### Detailed Description

### Reset Output

A microprocessor's ( $\mu P$ 's) reset input starts the  $\mu P$  in a known state. These  $\mu P$  supervisory circuits assert reset to prevent code execution errors during power-up, power-down, brownout conditions, or a watchdog timeout.

RESET is guaranteed to be a logic low for 0V <  $V_{CC}$  <  $V_{RST}$ , provided that VBATT is greater than 1V. Without a backup battery, RESET is guaranteed valid for  $V_{CC}$  > 1V. Once  $V_{CC}$  exceeds the reset threshold, an internal timer keeps RESET low for the reset timeout period; after this interval, RESET goes high (Figure 2).

If a brownout condition occurs (V<sub>CC</sub> dips below the reset threshold),  $\overline{\text{RESET}}$  goes low. Each time  $\overline{\text{RESET}}$  is asserted, it stays low for the reset timeout period. Any time V<sub>CC</sub> goes below the reset threshold, the internal timer restarts.

The watchdog timer can also initiate a reset. See the Watchdog Input section.

The MAX804\_/MAX805\_ active-high RESET output is open drain, and the inverse of the MAX690\_/MAX704\_/ MAX802\_/MAX806\_  $\overline{\text{RESET}}$  output.

### Reset Threshold

The MAX690T/MAX704T/MAX805T are intended for 3.3V systems with a  $\pm 5\%$  power-supply tolerance and a 10% system tolerance. Except for watchdog faults, reset will not assert as long as the power supply remains above 3.15V (3.3V - 5%). Reset is guaranteed to assert before the power supply falls below 3.0V.

The MAX690S/MAX704S/MAX805S are designed for 3.3V  $\pm 10\%$  power supplies. Except for watchdog faults, they are guaranteed not to assert reset as long as the supply remains above 3.0V (3.3V - 10%). Reset is guaranteed to assert before the power supply falls below 2.85V ( $V_{CC}$  - 14%).

The MAX690R/MAX704R/MAX805R are optimized for monitoring 3.0V  $\pm 10\%$  power supplies. Reset will not occur until V<sub>CC</sub> falls below 2.7V (3.0V - 10%), but is guaranteed to occur before the supply falls below 2.59V (3.0V - 14%).

The MAX802R/S/T, MAX804R/S/T, and MAX806R/S/T are respectively similar to the MAX690R/S/T, MAX805R/S/T, and MAX704R/S/T, but with tightened reset and power-fail threshold tolerances.

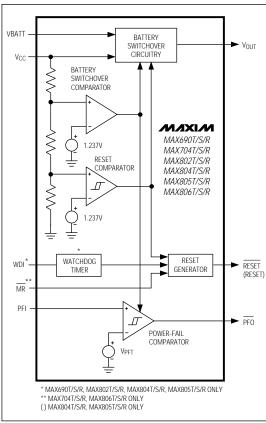


Figure 1. Block Diagram

### Watchdog Input (MAX690\_/802\_/804\_/805\_)

The watchdog circuit monitors the  $\mu P$ 's activity. If the  $\mu P$  does not toggle the watchdog input (WDI) within 1.6sec, a reset pulse is triggered. The internal 1.6sec timer is cleared by either a reset pulse or by a transition (low-to-high or high-to-low) at WDI. If WDI is tied high or low, a  $\overline{RESET}$  pulse is triggered every 1.8sec ( $t_{WD}$  plus  $t_{RS}$ ).

As long as reset is asserted, the timer remains cleared and does not count. As soon as reset is deasserted, the timer starts counting. Unlike the 5V MAX690 family, the watchdog function **cannot** be disabled.

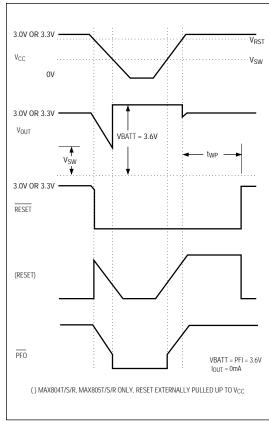


Figure 2. Timing Diagram

### Power-Fail Comparator

The PFI input is compared to an internal reference. If PFI is less than  $V_{\text{PFT}}$ ,  $\overline{\text{PFO}}$  goes low. The power-fail comparator is intended for use as an undervoltage detector to signal a failing power supply. However, the comparator does not need to be dedicated to this function because it is completely separate from the rest of the circuitry.

The power-fail comparator turns off and  $\overline{PFO}$  goes low when  $V_{CC}$  falls below  $V_{SW}$  on power-down. The power-fail comparator turns on as  $V_{CC}$  crosses  $V_{SW}$  on power-up. If the comparator is not used, connect PFI to ground and leave  $\overline{PFO}$  unconnected.  $\overline{PFO}$  may be connected to  $\overline{MR}$  on the MAX704\_MAX806\_ so that a low voltage on PFI will generate a reset (Figure 5b).

### **Backup-Battery Switchover**

In the event of a brownout or power failure, it may be necessary to preserve the contents of RAM. With a backup battery installed at VBATT, the devices automatically switch RAM to backup power when  $V_{\rm CC}$  falls

This family of  $\mu P$  supervisors (designed for 3.3V and 3V systems) doesn't always connect VBATT to  $V_{OUT}$  when VBATT is greater than  $V_{CC}$ . VBATT connects to  $V_{OUT}$  (through a  $140\Omega$  switch) when  $V_{CC}$  is below  $V_{SW}$  and VBATT is greater than  $V_{CC}$ , or when  $V_{CC}$  falls below 1.75V (typ) regardless of the VBATT voltage. This is done to allow the backup battery (e.g., a 3.6V lithium cell) to have a higher voltage than  $V_{CC}$ .

Switchover at V<sub>SW</sub> (2.40V) ensures that battery-backup mode is entered before V<sub>OUT</sub> gets too close to the 2.0V minimum required to reliably retain data in CMOS RAM. Switchover at higher V<sub>CC</sub> voltages would decrease backup-battery life. When V<sub>CC</sub> recovers, switchover is deferred until V<sub>CC</sub> rises above the reset threshold (V<sub>RST</sub>) to ensure a stable supply. V<sub>OUT</sub> is connected to V<sub>CC</sub> through a 3 $\Omega$  PMOS power switch.

### Manual Reset

A logic low on  $\overline{MR}$  asserts reset. Reset remains asserted while  $\overline{MR}$  is low, and for  $t_{WP}$  (200ms) after  $\overline{MR}$  returns high. This input has an internal  $70\mu A$  pull-up current, so it can be left open if it is not used.  $\overline{MR}$  can be driven with TTL or CMOS logic levels, or with open-drain/collector outputs. Connect a normally open momentary switch from  $\overline{MR}$  to GND to create a manual-reset function; external debounce circuitry is not required.

# Table 1. Input and Output Status in Battery-Backup Mode

PIN NAME	STATUS					
V <sub>OUT</sub>	Connected to VBATT through an internal 140Ω switch					
V <sub>C</sub> C	Disconnected from V <sub>OUT</sub>					
PFI	The power-fail comparator is disabled when VCC < VSW					
PFO	Logic low when V <sub>CC</sub> < V <sub>SW</sub> or PFI < V <sub>PFT</sub>					
WDI	The watchdog timer is disabled					
MR	Disabled					
RESET	Low logic					
RESET	High impedance					
VBATT	Connected to Vout					

### \_Applications Information

These  $\mu P$  supervisory circuits are not short-circuit protected. Shorting  $V_{OUT}$  to ground—excluding power-up transients such as charging a decoupling capacitor—destroys the device. Decouple both  $V_{CC}$  and VBATT pins to ground by placing 0.1 $\mu F$  capacitors as close to the device as possible.

### Using a SuperCap as a Backup Power Source

SuperCaps<sup>™</sup> are capacitors with extremely high capacitance values (e.g., order of 0.47F) for their size. Figure 3 shows two ways to use a SuperCap as a backup power source. The SuperCap may be connected through a diode to the 3V input (Figure 3a) or, if a 5V supply is also available, the SuperCap may be charged up to the 5V supply (Figure 3b) allowing a longer backup period. Since VBATT can exceed  $V_{CC}$  while  $V_{CC}$  is above the reset threshold, there are no special precautions when using these  $\mu P$  supervisors with a SuperCap.

### Operation without a Backup Power Source

These  $\mu P$  supervisors were designed for battery-backed applications. If a backup battery is not used, connect both VBATT and  $V_{OUT}$  to  $V_{CC}$ , or use a different  $\mu P$  supervisor such as the MAX706T/S/R or MAX708T/S/R.

### Replacing the Backup Battery

The backup power source can be removed while  $V_{CC}$  remains valid, if VBATT is decoupled with a 0.1 $\mu$ F capacitor to ground, without danger of triggering RESET/RESET. As long as  $V_{CC}$  stays above  $V_{SW}$ , battery-backup mode cannot be entered.

# Adding Hysteresis to the Power-Fail Comparator

The power-fail comparator has a typical input hysteresis of 10mV. This is sufficient for most applications where a power-supply line is being monitored through an external voltage divider (see the section *Monitoring an Additional Power Supply*).

If additional noise margin is desired, connect a resistor between  $\overline{PFO}$  and PFI as shown in Figure 4a. Select the ratio of R1 and R2 such that PFI sees 1.237V (V\_{PFT}) when V\_{IN} falls to its trip point (V\_{TRIP}). R3 adds the hysteresis and will typically be more than 10 times the value of R1 or R2. The hysteresis window extends both above (V\_H) and below (V\_L) the original trip point (V\_{TRIP}).

 $<sup>^{\</sup>text{\tiny TM}}$  SuperCap is a trademark of Baknor Industries.

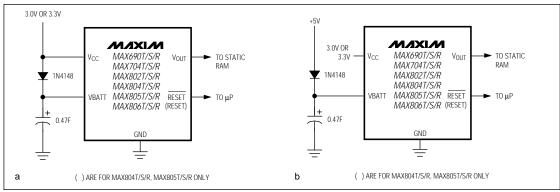


Figure 3. Using a SuperCap as a Backup Power Source

Connecting an ordinary signal diode in series with R3, as shown in Figure 4b, causes the lower trip point  $(V_L)$  to coincide with the trip point without hysteresis  $(V_{TRIP})$ , so the entire hysteresis window occurs above  $V_{TRIP}$ . This method provides additional noise margin without compromising the accuracy of the power-fail threshold when the monitored voltage is falling. It is useful for accurately detecting when a voltage falls past a threshold.

The current through R1 and R2 should be at least 1 $\mu$ A to ensure that the 25nA (max over extended temperature range) PFI input current does not shift the trip point. R3 should be larger than 10k $\Omega$  so it does not load down the PFO pin. Capacitor C1 adds additional noise rejection.

### Monitoring an Additional Power Supply

These  $\mu P$  supervisors can monitor either positive or negative supplies using a resistor voltage divider to PFI. PFO can be used to generate an interrupt to the  $\mu P$  (Figure 5). Connecting PFO to MR on the MAX704 and MAX806 causes reset to assert when the monitored supply goes out of tolerance. Reset remains asserted as long as PFO holds MR low, and for 200ms after PFO goes high.

# Interfacing to µPs with Bidirectional Reset Pins

 $\mu$ Ps with bidirectional reset pins, such as the Motorola 68HC11 series, can contend with the MAX690\_/MAX704\_/MAX802\_/MAX806\_ RESET output. If, for

example, the  $\overline{RESET}$  output is driven high and the  $\mu P$  wants to pull it low, indeterminate logic levels may result. To correct this, connect a 4.7k  $\Omega$  resistor between the  $\overline{RESET}$  output and the  $\mu P$  reset I/O, as in Figure 6. Buffer the  $\overline{RESET}$  output to other system components.

### Negative-Going V<sub>CC</sub> Transients

While issuing resets to the  $\mu P$  during power-up, power-down, and brownout conditions, these supervisors are relatively immune to short-duration negative-going  $V_{CC}$  transients (glitches). It is usually undesirable to reset the  $\mu P$  when  $V_{CC}$  experiences only small glitches.

Figure 7 shows maximum transient duration vs. reset-comparator overdrive, for which reset pulses are not generated. The graph was produced using negative-going  $V_{CC}$  pulses, starting at 3.3V and ending below the reset threshold by the magnitude indicated (reset comparator overdrive). The graph shows the maximum pulse width a negative-going  $V_{CC}$  transient may typically have without causing a reset pulse to be issued. As the amplitude of the transient increases (i.e., goes farther below the reset threshold), the maximum allowable pulse width decreases. Typically, a  $V_{CC}$  transient that goes 100mV below the reset threshold and lasts for  $40\mu\text{s}$  or less will not cause a reset pulse to be issued.

A 100nF bypass capacitor mounted close to the  $V_{CC}$  pin provides additional transient immunity.

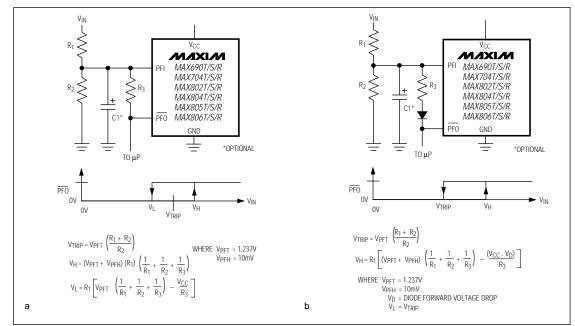


Figure 4. a) Adding Additional Hysteresis to the Power-Fail Comparator b) Shifting the Additional Hysteresis above V<sub>PFT</sub>

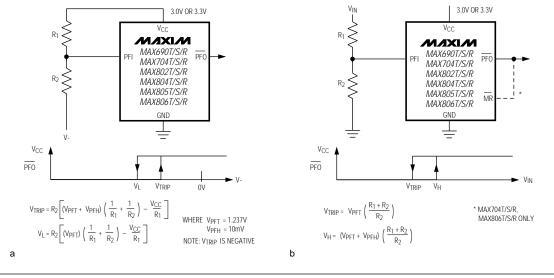


Figure 5. Using the Power-Fail Comparator to Monitor an Additional Power Supply

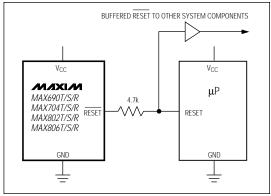
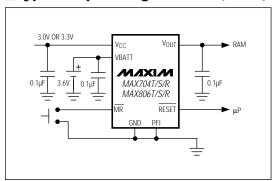


Figure 6. Interfacing to μPs with Bidirectional Reset I/O

# 100 80 VCC = 3.3V T<sub>A</sub> = +25°C 100 100 1000 RESET COMPARATOR OVERDRIVE (V<sub>RST</sub> - V<sub>CC</sub>) (mV)

Figure 7. Maximum Transient Duration without Causing a Reset Pulse vs. Reset Comparator Overdrive

## \_Typical Operating Circuits (cont.)



### \_Ordering Information (continued)

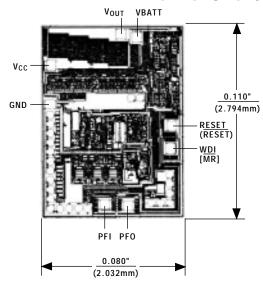
PART**	TEMP. RANGE	PIN-PACKAGE
MAX704_CPA	0°C to +70°C	8 Plastic DIP
MAX704_CSA	0°C to +70°C	8 SO
MAX704_C/D	0°C to +70°C	Dice*
MAX704_EPA	-40°C to +85°C	8 Plastic DIP
MAX704_ESA	-40°C to +85°C	8 SO
MAX704_MJA	-55°C to +125°C	8 CERDIP
MAX802_CPA	0°C to +70°C	8 Plastic DIP
MAX802_CSA	0°C to +70°C	8 SO
MAX802_C/D	0°C to +70°C	Dice*
MAX802_EPA	-40°C to +85°C	8 Plastic DIP
MAX802_ESA	-40°C to +85°C	8 SO
MAX802_MJA	-55°C to +125°C	8 CERDIP
MAX804_CPA	0°C to +70°C	8 Plastic DIP
MAX804_CSA	0°C to +70°C	8 SO
MAX804_C/D	0°C to +70°C	Dice*
MAX804_EPA	-40°C to +85°C	8 Plastic DIP
MAX804_ESA	-40°C to +85°C	8 SO
MAX804_MJA	-55°C to +125°C	8 CERDIP
MAX805_CPA	0°C to +70°C	8 Plastic DIP
MAX805_CSA	0°C to +70°C	8 SO
MAX805_C/D	0°C to +70°C	Dice*
MAX805_EPA	-40°C to +85°C	8 Plastic DIP
MAX805_ESA	-40°C to +85°C	8 SO
MAX805_MJA	-55°C to +125°C	8 CERDIP
MAX806_CPA	0°C to +70°C	8 Plastic DIP
MAX806_CSA	0°C to +70°C	8 SO
MAX806_C/D	0°C to +70°C	Dice*
MAX806_EPA	-40°C to +85°C	8 Plastic DIP
MAX806_ESA	-40°C to +85°C	8 SO
MAX806_MJA	-55°C to +125°C	8 CERDIP

\* Contact factory for dice specifications.

MAX690T/S/R, 704T/S/R, 802T/S/R, 804-806T/S/R

\*\* These parts offer a choice of reset threshold voltage. Select the letter corresponding to the desired nominal reset threshold voltage (T = 3.075V, S = 2.925V, R = 2.625V) and insert it into the blank to complete the part number.

### \_Chip Topography



- ( ) ARE FOR MAX804T/S/R, MAX805T/S/R.
- [] ARE FOR MAX704T/S/R, MAX806T/S/R.

### TRANSISTOR COUNT: 802;

SUBSTRATE IS CONNECTED TO THE HIGHER OF  $V_{\text{CC}}$  OR VBATT, AND MUST BE FLOATED IN ANY HYBRID DESIGN.

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